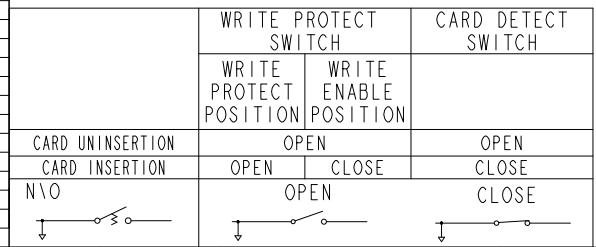


- NOTES :
- MATERIAL :
 - HOUSING:HEAT RESISTANCE POLYMER, UL94 V-0, BLACK COLOR.
 - SHELL:STAINLESS STEEL.
 - CONTACT: COPPER ALLOY.
 - FINISH :
 - CONTACT: GOLD PLATING ON CONTACT AREA, GOLD FLASH ON SOLDERTAIL AREA. 50μ" MIN NICKEL PLATING OVERALL.
 - SHELL: 300" MIN SOLDERABLE NICKEL PLATED OVER ALL.
 - ELECTRICAL CHARACTERISTICS:
 - OPERATING VOLTAGE : 100V AC(rms)/DC.
 - CURRENT RATING : 0.5 A.
 - OPERATING TEMPERATURE: -25°C~+85°C.
 - CONTACT RESISTANCE: 100 m OHMS MAX.
 - INSULATION RESISTANCE: 1000M OHMS MIN. AT 250VDC.
 - DIELECTRIC WITHSTANDING VOLTAGE:500 VAC/1MINUTE.

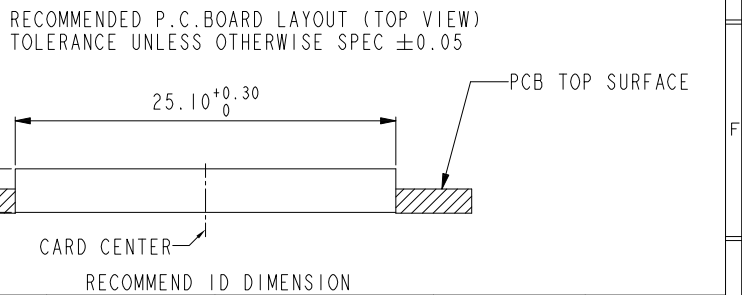
PART.NO.: TW262-AN401-**-**

08: 功能区镀金10", 锡脚Gold Flash
 09: 功能区镀金30", 锡脚Gold Flash
 10: 功能区镀金50", 锡脚Gold Flash
 11: 功能区镀金150", 锡脚Gold Flash
 12: 功能区镀金300", 锡脚Gold Flash

PIN No.	FUNCTION			
	SD MODE	UHS II MODE	MMC MODE	
No. 1	#9	DAT2	-	-
No. 2	#1	CD/DAT3	-	RSV
No. 3	#2	CMD	-	CMD
No. 4	#3	-	VSS1	VSS1
No. 5	#4	VDD	VDD1	VDD
No. 6	#5	CLK	-	CLK
No. 7	#6	-	VSS2	VSS2
No. 8	CD	CARD DETECT		
No. 9	#7	DAT0	RCLK+	DAT
No. 10	#8	DAT1	RCLK-	-
No. 11	WP	WRITE PROTECT		
No. 12	#10	-	VSS3	-
No. 13	#11	-	D0+	-
No. 14	#12	-	D0-	-
No. 15	#13	-	VSS4	-
No. 16	#14	-	VDD2	-
No. 17	#15	-	D1-	-
No. 18	#16	-	D1+	-
No. 19	#17	-	VSS5	-
No. 20	#18	-	-	VDD3



- [Hatched Area] : PAD AREA
- [White Area] : PCB EDGE
- [Cross-hatched Area] : NO PART AREA



GENERAL	TOLERANCE	DWG.NO.	TW262-AN401-00	PART.NO.	TW262-AN401-**-**	DRAWN	Toff 2023.02.20
x.±0.50	x. °± 5 °	REV.	X1	TITLE	SD7.0 No Push反向沉板1.40	CHECKED	
.x±0.25	.x °± 2 °	SIZE		SHEET	1/2	APPROVED	
.xx±0.15	.xx ± 1 °	A4					

UNIT mm SCALE 1:1

OLN 东莞市欧联电子科技有限公司
 DONGGUAN OLN ELECTRONICS TECHNOLOGY CO., LTD.